Amendment to the Specification

Please replace the title with the new title "FLAT PANEL DISPLAY ARRARATUS WITH GROUNDED PCB"

Please replace paragraph [0008] of the published patent application 2004/0257515 A1 with the following amended paragraph:

[0008] As a method Methods of bonding an LCD driver IC (integrated chip) to the TFT array substrate, there are include a TAB (tape automated bonding) method, a COG (chip on glass) method, etc.

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